

UTC UNISONIC TECHNOLOGIES CO., LTD

3N70K-MK **Preliminary** Power MOSFET

3A, 700V N-CHANNEL **POWER MOSFET**

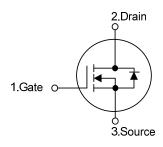
DESCRIPTION

The UTC 3N70K-MK is a high voltage and high current power MOSFET, designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

FEATURES

- * $R_{DS(ON)}$ < 4.20 @ V_{GS} = 10 V
- * Low reverse transfer capacitance
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

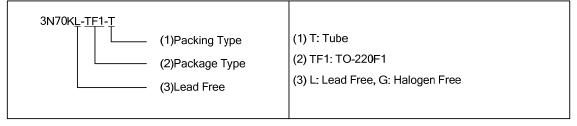
SYMBOL



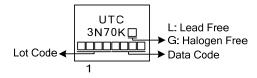
ORDERING INFORMATION

Ordering Number		Dooksaya	Pin Assignment			Deeking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
3N70KL-TF1-T	3N70KG-TF1-T	TO-220F1	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source



MARKING



TO-220F1

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■ ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	700	V	
Gate-Source Voltage		V_{GSS}	±30	V	
Avalanche Current (Note 2)		I _{AR}	3.0	Α	
Continuous Drain Current		I_D	3.0	Α	
Pulsed Drain Current (Note 2)		I _{DM}	12	Α	
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	60	mJ	
	Repetitive (Note 2)	E _{AR}	7.5	mJ	
Power Dissipation		7	34	W	
Derate above 25°C		P _D	0.27	W/°C	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns	
Junction Temperature		TJ	+150	°C	
Operating Temperature		T _{OPR}	-55 ~ +150	°C	
Storage Temperature		T _{STG}	-55 ~ + 150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L = 13.33mH, I_{AS} = 3A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C
- 4. $I_{SD} \le 3.0 A$, di/dt $\le 200 A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ_{JA}	62.5	°C/W	
Junction to Case	θ_{JC}	3.7	°C/W	

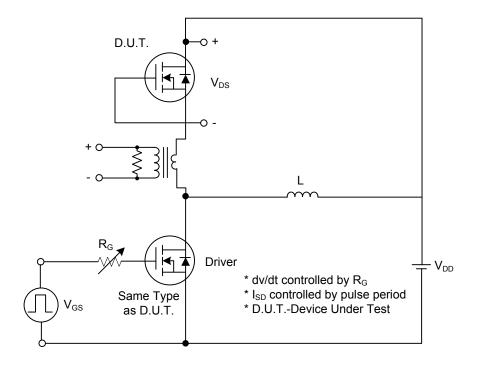
■ **ELECTRICAL CHARACTERISTICS** (T_C =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS					•			
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} = 0 V, I _D = 250μA	700			V	
Drain-Source Leakage Current		I _{DSS}	V _{DS} = 700 V, V _{GS} = 0 V			10	μA	
Cata Cauras I sakara Current	orward	1000	V _{GS} = 30 V, V _{DS} = 0 V			100	nA	
Gate-Source Leakage Current	Reverse		$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA	
Breakdown Voltage Temperature Coefficient		$\triangle BV_{DSS}/\triangle T_{J}$	$I_D = 250\mu A$, Referenced to $25^{\circ}C$		0.6		V/°C	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5		4.5	V	
Static Drain-Source On-State Resistance		R _{DS(ON)}	$V_{GS} = 10 \text{ V}, I_D = 1.5 \text{A}$			4.20	Ω	
DYNAMIC CHARACTERISTICS								
Input Capacitance		C _{ISS}	V 05.V.V 0.V		422	510	рF	
Output Capacitance		Coss	V_{DS} = 25 V, V_{GS} = 0 V, f = 1MHz		37	55	pF	
Reverse Transfer Capacitance		C_{RSS}			4.4	11	pF	
SWITCHING CHARACTERISTICS								
Turn-On Delay Time		t _{D(ON)}			42		ns	
Turn-On Rise Time		t_R	$V_{DD} = 30V, I_D = 0.5A,$		14		ns	
Turn-Off Delay Time		$t_{D(OFF)}$	$R_G = 25\Omega \text{ (Note 1, 2)}$		94		ns	
Turn-Off Fall Time		t_{F}			14		ns	
Total Gate Charge		Q_G	V _{DS} = 50V,I _D = 1.3A,		13.7	16	nC	
Gate-Source Charge		Q_GS	V _{GS} = 10 V (Note 1, 2)		4.3		nC	
Gate-Drain Charge		Q_GD	VGS= 10 V (Note 1, 2)		1.38		nC	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Drain-Source Diode Forward Voltage		V_{SD}	$V_{GS} = 0 \text{ V}, I_{S} = 3.0 \text{ A}$			1.4	V	
Maximum Continuous Drain-Source Diode		Is				3.0	Α	
Forward Current		ıs 				3.0		
Maximum Pulsed Drain-Source Diode		I _{SM}				12	Α	
Forward Current						12	/ \	

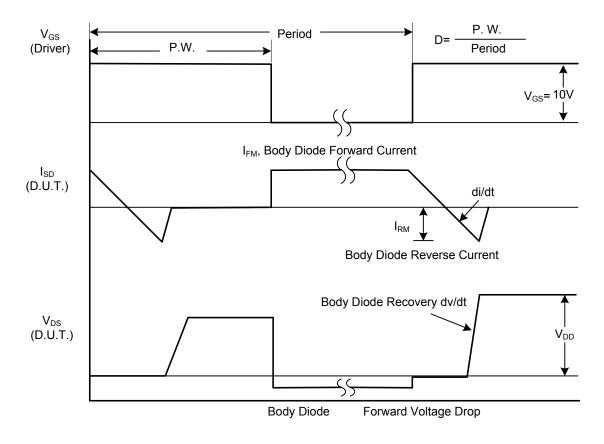
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle≤2%

^{2.} Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

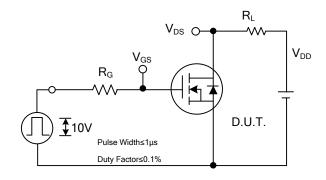


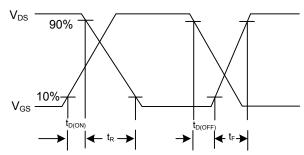
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

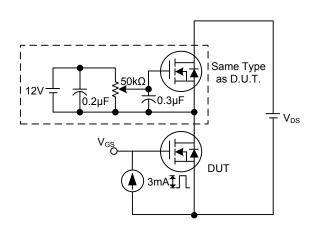
■ TEST CIRCUITS AND WAVEFORMS (Cont.)

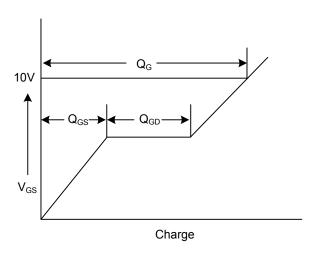




Switching Test Circuit

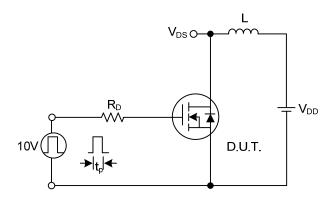
Switching Waveforms

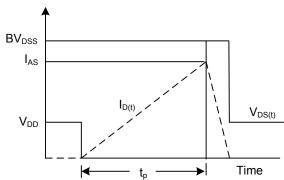




Gate Charge Test Circuit

Gate Charge Waveform





Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

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